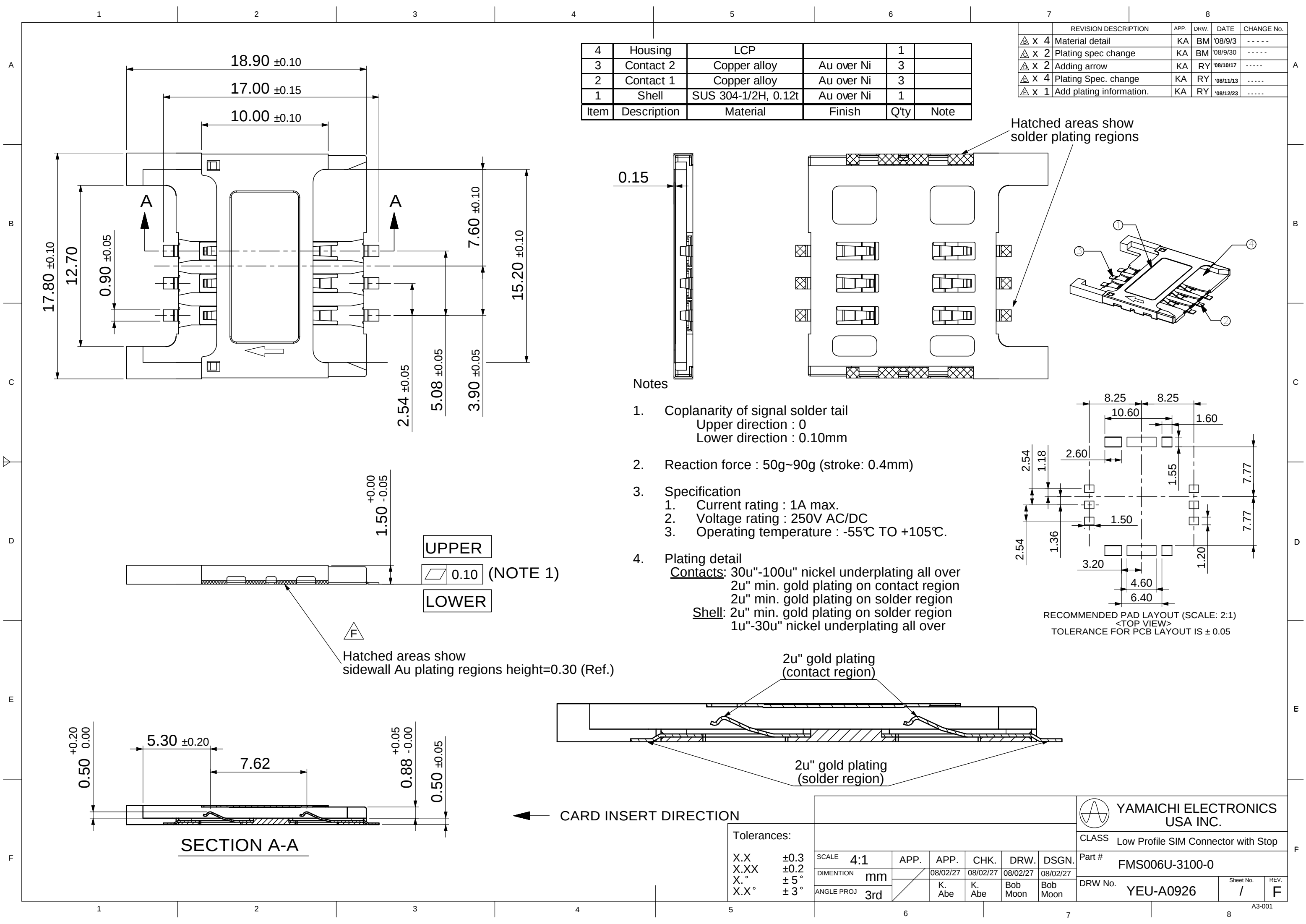




4	Housing	LCP		1	
3	Contact 2	Copper alloy	Au over Ni	3	
2	Contact 1	Copper alloy	Au over Ni	3	
1	Shell	SUS 304-1/2H, 0.12t	Au over Ni	1	
Item	Description	Material	Finish	Q'ty	Note

	REVISION DESCRIPTION	APP.	DRW.	DATE	CHANGE No.
△ X 4	Material detail	KA	BM	'08/9/3	-----
△ X 2	Plating spec change	KA	BM	'08/9/30	-----
△ X 2	Adding arrow	KA	RY	'08/10/17	-----
△ X 4	Plating Spec. change	KA	RY	'08/11/13	-----
△ X 1	Add plating information.	KA	RY	'08/12/23	-----

- Notes
- Coplanarity of signal solder tail
Upper direction : 0
Lower direction : 0.10mm
 - Reaction force : 50g~90g (stroke: 0.4mm)
 - Specification
 - Current rating : 1A max.
 - Voltage rating : 250V AC/DC
 - Operating temperature : -55℃ TO +105℃.
 - Plating detail
Contacts: 30u"-100u" nickel underplating all over
2u" min. gold plating on contact region
2u" min. gold plating on solder region
Shell: 2u" min. gold plating on solder region
1u"-30u" nickel underplating all over

RECOMMENDED PAD LAYOUT (SCALE: 2:1)
<TOP VIEW>
TOLERANCE FOR PCB LAYOUT IS ± 0.05

SECTION A-A

CARD INSERT DIRECTION

Tolerances:

X.X	±0.3
X.XX	±0.2
X.°	± 5°
X.X°	± 3°

						YAMAICHI ELECTRONICS USA INC.	
SCALE 4:1						CLASS Low Profile SIM Connector with Stop	
DIMENSION mm						Part # FMS006U-3100-0	
ANGLE PROJ 3rd						DRW No. YE-U-A0926	
						Sheet No. /	REV. F

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